

HVL396CM

Variable Capacitance Diode for VCO

REJ03G0013-0200Z

Rev.2.00

Jun 07, 2004

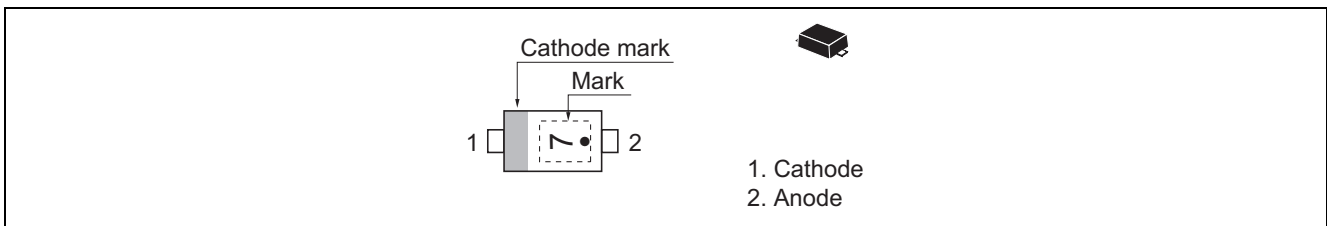
Features

- High capacitance ratio. ($n = 2.62$ min)
- Low series resistance. ($r_s = 0.40 \Omega$ max)
- Thin Extremely small Flat Package (TEFP) is suitable for surface mount design.

Ordering Information

Type No.	Laser Mark	Package Code
HVL396CM	7	TEFP

Pin Arrangement



Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Value	Unit
Reverse voltage	V_R	10	V
Junction temperature	T_j	125	°C
Storage temperature	T_{stg}	-55 to +125	°C

Electrical Characteristics

(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse current	I_{R1}	—	—	10	nA	$V_R = 10\text{ V}$
	I_{R2}	—	—	50		$V_R = 10\text{ V}, T_a = 60^\circ\text{C}$
Capacitance	C_1	14.6	—	15.8	pF	$V_R = 1\text{ V}, f = 1\text{ MHz}$
	C_4	5.20	—	5.80		$V_R = 4\text{ V}, f = 1\text{ MHz}$
Capacitance ratio	n	2.62	—	—	—	C_1 / C_4
Series resistance	r_s	—	—	0.40	Ω	$V_R = 1\text{ V}, f = 470\text{ MHz}$

Notes: 1. Please do not use the soldering iron due to avoid high stress to the TAFP package.

2. The material of lead is exposed for cutting plane. There for, soldering nature of lead tip part is considered as unquestioned. Please kindly consider soldering nature.

Main Characteristic

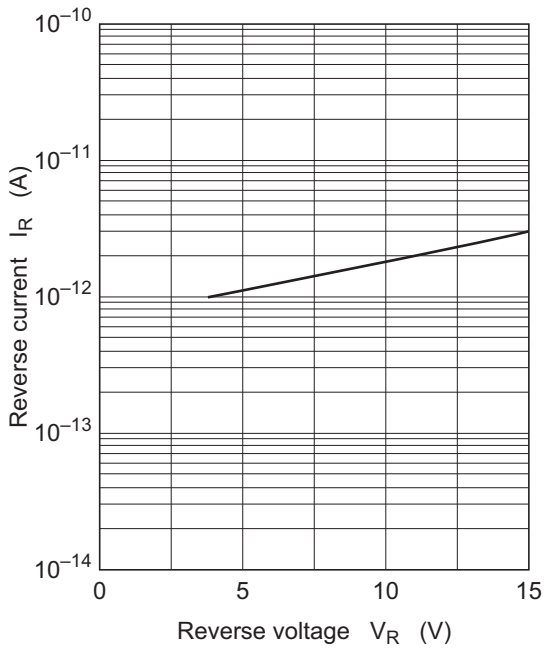


Fig.1 Reverse current vs. Reverse voltage

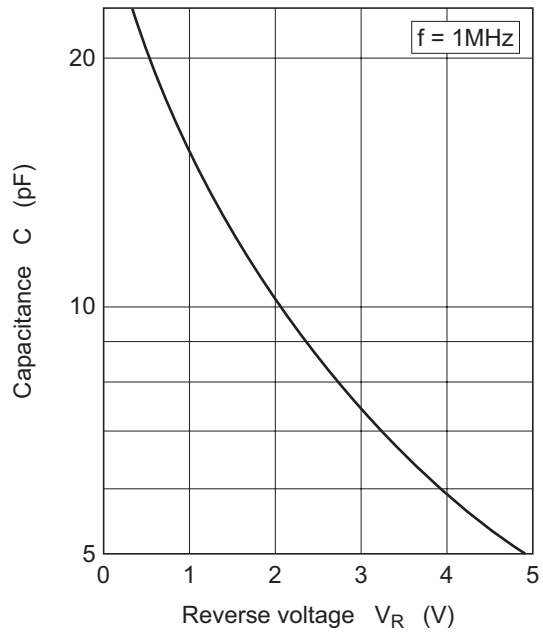


Fig.2 Capacitance vs. Reverse voltage

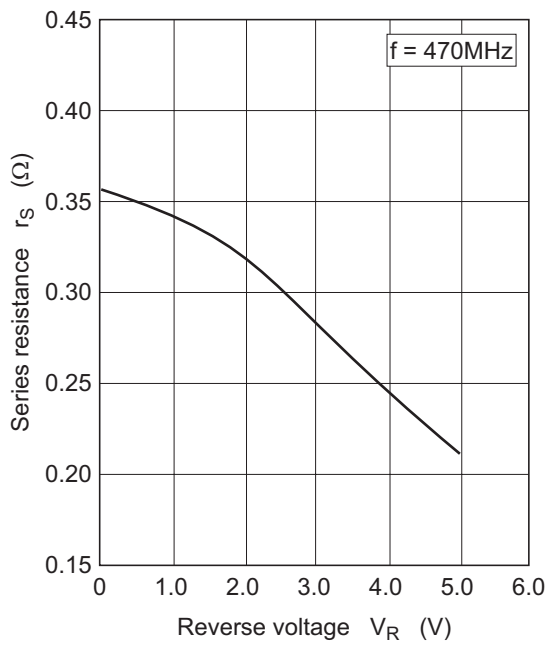


Fig.3 Series resistance vs. Reverse voltage

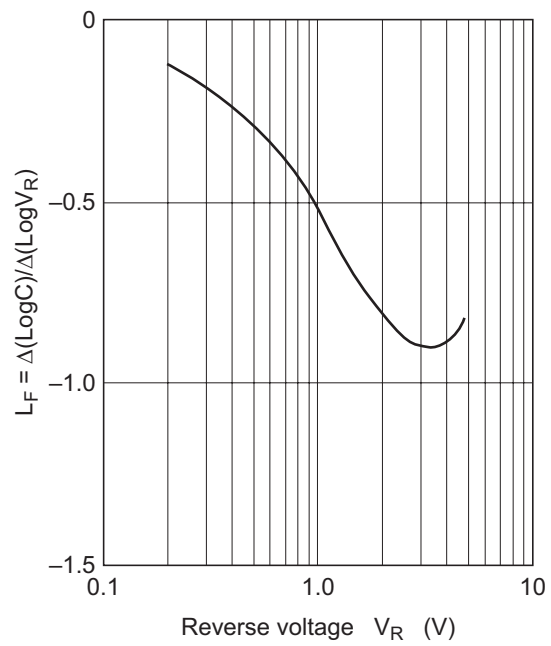
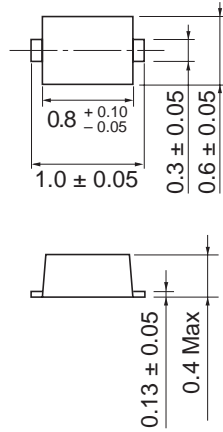


Fig.4 Linearity factor vs. Reverse voltage

Package Dimensions

As of January, 2003
Unit: mm



Package Code	TEFP
JEDEC	—
JEITA	—
Mass (reference value)	0.0006 g

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Tel: <44> (1628) 585 100, Fax: <44> (1628) 585 900

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Renesas Technology (Shanghai) Co., Ltd.

26/F., Ruijin Building, No.205 Maoming Road (S), Shanghai 200020, China
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

Renesas Technology Singapore Pte. Ltd.

1, Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632
Tel: <65> 6213-0200, Fax: <65> 6278-8001

